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510-643-9443V
510-643-8302F

Board Name Main HVPS
Revision 09
Part Number
Quantity 15
Dates 5, 10, 15, 20 days

Military P55110
FR4
No buried vias
Board Dimensions – see enclosed .dxf file
Number of layers 3
Board thickness - .062
Minimum track and width .010
Copper – 1ounce inner and outer
Surface mount? Yes
Tin/Lead reflow or hot air level
Solder mask top and bottom, LPI using Epic 200, or lower outgassing material
Silkscreen white, M9N with CAT-9 catalyst from Hysol, or lower outgassing material
Certificate of compliance
Coupons per mil P55110
Please keep the solder resist away from the parallel lines below that divide up the board into three sections.

Keep the solder resist at least +/- 25 mils from here

